

40V N-Channel Enhancement Mode MOSFET

Voltage 40 V

Current

120 A

Features

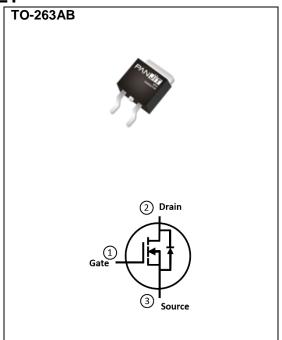
- RDS(ON), VGS@10V, ID@90A<1.92m Ω
- RDS(ON), VGS@7V, ID@50A<2.4mΩ
- Excellent FOM
- Standard Level Drive
- AEC-Q101 qualified
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

Mechanical Data

• Case: TO-263AB Package

• Terminals : Solderable per MIL-STD-750, Method 2026

• Approx. Weight: 1.6924 grams



Maximum Ratings and Thermal Characteristics (T_A=25°C unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS
Drain-Source Voltage		V _{DS}	40	V
Gate-Source Voltage		V _{GS}	±20	V
Continuous Drain Current(Note 3)	T _C =25°C		120	
	T _C =100°C	I _D	120	А
Pulsed Drain Current ^(Note 1)	Tc=25°C	I _{DM}	480	
Power Dissipation	Tc=25°C	D	300	10/
	T _C =100°C	Po	150	W
Continuous Drain Current(Note 4)	T _A =25°C	,	33	^
	T _A =70°C	I _D	27.6	A
Power Dissipation	T _A =25°C	Po	3.8	w
	T _A =70°C	PD	2.6	VV
Single Pulse Avalanche Current(Note 5)		IAS	29.2	А
Single Pulse Avalanche Energy ^(Note 5)		Eas	438	mJ
Operating Junction and Storage Temperature Range		T _J ,T _{STG}	-55~175	°C
Thermal Resistance ^(Note 4)	Junction to Case	R _{θJC}	0.5	°C/W
	Junction to Ambient	$R_{\theta JA}$	40	C/VV



Electrical Characteristics (T_A=25°C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS	
Static							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	40	-	-	V	
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =50uA	2	2.8	3.5		
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =10V, I _D =90A	-	1.54	1.92	mΩ	
		V _{GS} =7V, I _D =50A	-	1.82	2.4		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =40V, V _{GS} =0V	-	-	1	uA	
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA	
Dynamic ^(Note 6)	•			•			
Total Gate Charge	Q_g	V _{DS} =32V, I _D =90A,	ı	85	110		
Gate-Source Charge	Qgs		i	29	-	nC	
Gate-Drain Charge	Q_{gd}	V _{GS} =10V	-	16	-		
Input Capacitance	Ciss	.,	-	5990	7790	pF	
Output Capacitance	Coss	V _{DS} =25V, V _{GS} =0V,	-	1250	1630		
Reverse Transfer Capacitance	Crss	f=1MHz	-	80	140		
Gate resistance	Rg	f=1MHz	-	0.94	-	Ω	
Turn-On Delay Time	td _(on)	.,	-	25	-		
Turn-On Rise Time	tr	V _{DS} =32V, I _D =90A,	-	14	-		
Turn-Off Delay Time	td _(off)	$V_{GS}=10V, R_{G}=3\Omega$	-	45	-	ns	
Turn-Off Fall Time	tf	(Note 2)	-	17	-		
Drain-Source Diode	1				•	•	
Diode Forward Current	Is	T 05°0	-	-	120		
Pulsed Diode Forward Current	I _{SM}	T _C =25°C	-	-	480	Α	
Diode Forward Voltage	V_{SD}	Is=20A, V _{GS} =0V	-	0.75	1.3	V	
Reverse Recovery Time	Trr	V _{DD} =32V,V _{GS} =0V	-	42	-	ns	
Reverse Recovery Charge	Qrr	I _S =20A,dI _S /dt=100A/us	-	30	-	nC	

NOTES:

- 1. Pulse width < 300us, Duty cycle < 2%.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Chip capability with an R_{BJC}=0.5°C/W, Package limited 120A.
- 4. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch² with 2oz.square pad of copper.
- 5. E_{AS} is calculated based on the condition of L=1mH, I_{AS}=29.6A, V_{DD}=30V, V_{GS}=10V. 100% test at L=0.5mH, I_{AS}=29.2A in production.
- 6. Guaranteed by design, not subject to production testing.



TYPICAL CHARACTERISTIC CURVES

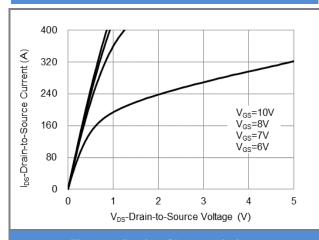


Fig.1 On-Region Characteristics

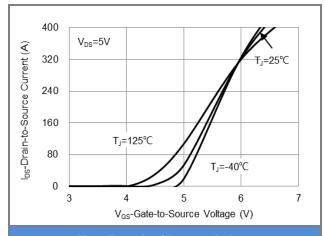


Fig.2 Transfer Characteristics

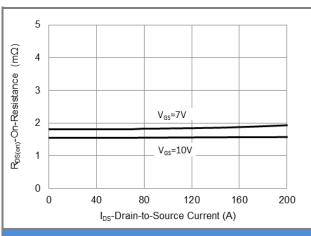


Fig.3 On-Resistance vs. Drain Current

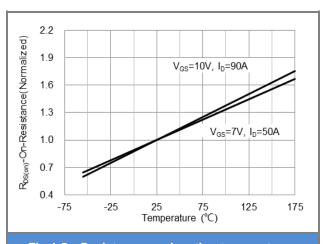
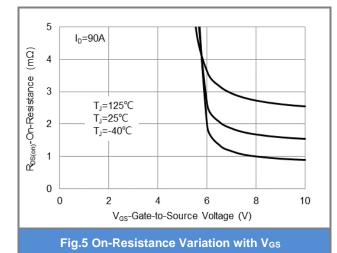
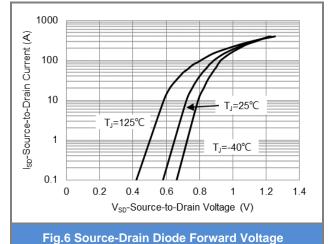


Fig.4 On-Resistance vs. Junction temperature







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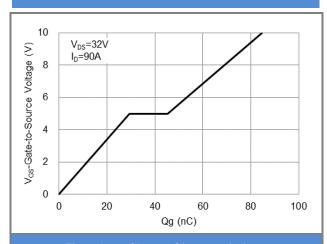


Fig.7 Gate-Charge Characteristics

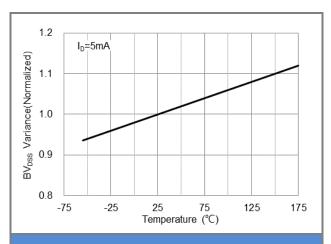


Fig.8 Breakdown Voltage Variation vs. Temperature

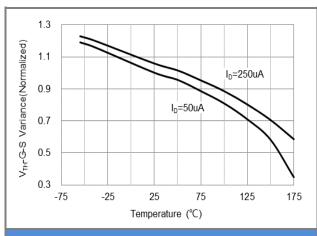


Fig.9 Threshold Voltage Variation with Temperature

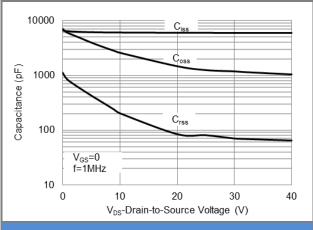
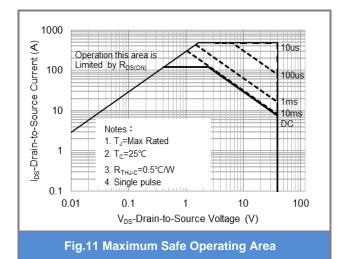


Fig.10 Capacitance vs. Drain-Source Voltage



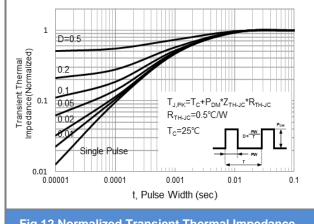


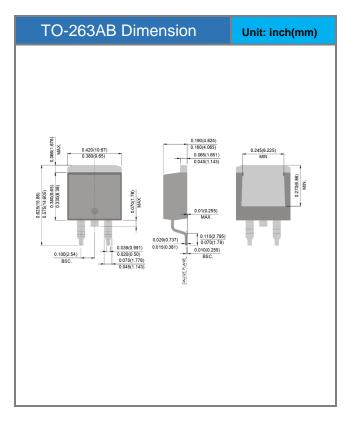
Fig.12 Normalized Transient Thermal Impedance

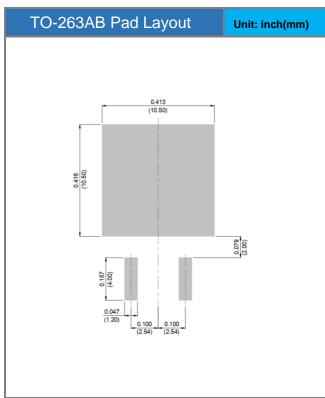


Product and Packing Information

Part No.	Package Type	Packing Type	Marking	
PJB120N04V-AU	TO-263AB	800 pcs / 13" reel	120N04V	

Packaging Information & Mounting Pad Layout







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